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Declaration and Power of Attorney For Patent Application

特許出願宣言書及び委任状

Japanese Language Declaration

日本語宣言書

下記の氏名の発明者として、私は以下の通り宣言します。	As a below named inventor, I hereby declare that:
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下記の名称の発明に関して請求範囲に記載され、特許出願している発明内容について、私が最初かつ唯一の発明者(下記の氏名が一つの場合)もしくは最初かつ共同発明者であると(下記の名称が複数の場合)信じています。	I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled
	SEMICONDUCTOR DEVICE AND ITS MANUFACTURING
	METHOD
上記発明の明細書(下記の欄で×印がついていない場合は、 本書に添付)は、	The specification of which is attached hereto unless the following box is checked:
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Prior Foreign Application(s)
外国での先行出願
2000-320794 Japan
(Number) (Country)
(番号) (国名)

(Number) (Country) (番号) (国名)

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Priority Not Claimed 優先権主張なし
20 / October / 2000
(Day/Month/Year Filed)
(出願年月日)
(Day/Month/Year Filed)
(出願年月日)

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(Application No.) (Filing Date) (出願番号) (出願日)

I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s), or 365(c) of any PCT international application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of Title 35, United States Code Section 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of application.

(Status: Patented, Pending, Abandoned) (現況:特許許可済、係属中、放棄済) (Status: Patented, Pending, Abandoned) (現況:特許許可済、係属中、放棄済)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the

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委任状: 私は下記の発明者として、本出願に関する一切の 手続きを米特許商標局に対して遂行する弁理士または代理人 として、下記の者を指名いたします。(弁護士、または代理 人の氏名及び登録番号を明記のこと) POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith (list name and registration number)

John R. Mattingly, Reg. No.30,293; Daniel J. Stanger, Reg. No.32,846; Shrinath Malur, Reg. No.34,663; Gene W. Stockman, Reg. No.21,021; Jeffrey M. Ketchum, Reg. No.31,174; Scott W. Brickner, Reg. No.34553;

書類送付先

Send Correspondence to:

Mattingly, Stanger & Malur, P.C 1800 Diagonal Road, Suite 370 Alexandria, Virginia 22314

直接電話連絡先: (名前及び電話番号)

Direct Telephone Calls to: (name and telephone number)

Telephone: (703) 684-1120 Fax: (703) 684-1157

唯一または第一発明者3	各 	Full name of sole or first inventor Yoshinori MIYAKI
発明者の署名	日付	Inventor's signature Date
住所	Residence	
	Tachikawa, Japan	
国籍	Citizenship	
	Japan	
私書箱	Post Office Address	
	c/o Hitachi, Ltd., Intellectual Property Group	
	New Marunouchi Bldg. 5-1, Marunouchi 1-chome,	
	Chiyoda-ku, Tokyo 100-8220, Japan	

(第二以降の共同発明者についても同様に記載し、署名をすること)

(Supply similar information and signature for second and subsequent joint inventors.)

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Hiromichi SUZUKI Second inventor's signature ; Date
Fromichi Suzuki 4/11/2001
Residence
Tokyo, Japan
Citizenship
Japan
Post Office Address
c/o Hitachi, Ltd., Intellectual Property Group
New Marunouchi Bldg. 5-1, Marunouchi 1-chome,
Chiyoda-ku, Tokyo 100-8220, Japan
Full name of third joint inventor, if any
Third inventor's signature Date
Residence
Citizenship
Post Office Address
Full name of fourth joint inventor, if any
Fourth inventor's signature Date
Residence
Citizenship
Post Office Address
Full name of fifth joint inventor, if any
Fifth inventor's signature Date
Residence
Citizenship
Post Office Address